

**Technical Data Sheet****1206 Package Chip LEDs (1.1mm Height)****15-21/BHC-AN1P2/2T****Features**

- Package in 8mm tape on 7" diameter reel.
- Compatible with automatic placement equipment.
- Compatible with infrared and vapor phase reflow solder process.
- Mono-color type.
- Pb-free.

Descriptions

- The 15-21 SMD Taping is much smaller than lead frame type components, thus enable smaller board size, higher packing density, reduced storage space and finally smaller equipment to be obtained.
- Besides, lightweight makes them ideal for miniature applications. etc.

Applications

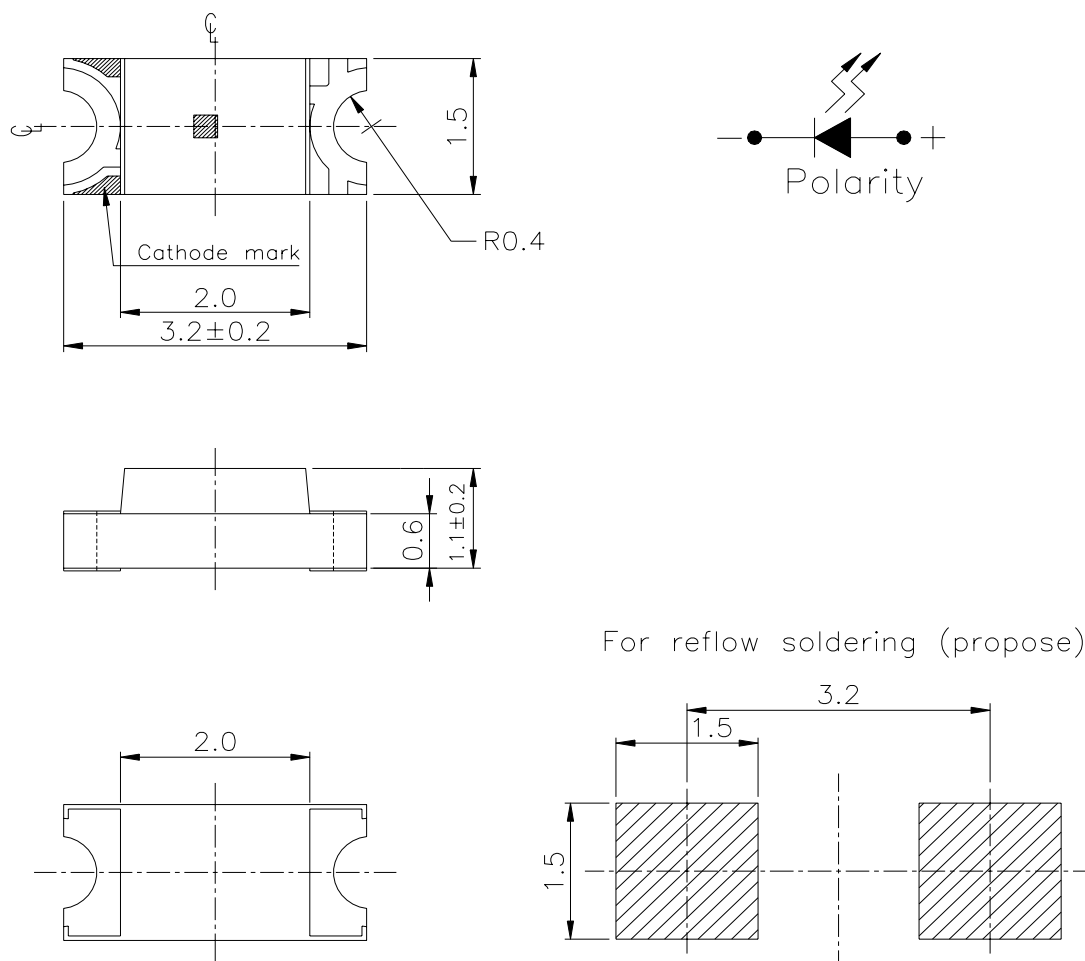
- Automotive: backlighting in dashboard and switch.
- Telecommunication: indicator and backlighting in telephone and fax.
- Flat backlight for LCD, switch and symbol.
- General use.

**Device Selection Guide**

PART No.	Chip		Lens Color
	Material	Emitted Color	
15-21/BHC-AN1P2/2T	InGaN	Blue	Water Clear

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Package Outline Dimensions



Note: The tolerance unless mentioned is $\pm 0.1\text{mm}$, unit is mm.

15-21/BHC-AN1P2/2T
Absolute Maximum Ratings (Ta=25℃)

Parameter	Symbol	Rating	Unit
Reverse Voltage	V _R	5	V
Forward Current	I _F	25	mA
Operating Temperature	T _{opr}	-40 ~ +85	℃
Storage Temperature	T _{stg}	-40~ +90	℃
Soldering Temperature	T _{sol}	260 (for 5 second)	℃
Electrostatic Discharge	ESD	150	V
Power Dissipation	P _d	110	mW
Peak Forward Current (Duty 1/10 @1KHz)	I _{FP}	100	mA

Electro-Optical Characteristics (Ta=25℃)

Parameter	Symbol	Min.	Typ.	Max.	Unit	Condition
Luminous Intensity	I _v	28.5	40	72	mcd	I _F =20mA
Viewing Angle	2 θ 1/2	-----	130	-----	deg	
Peak Wavelength	λ _p	-----	468	-----	nm	
Dominant Wavelength	λ _d	-----	470	-----	nm	
Spectrum Radiation Bandwidth	△ λ	-----	25	-----	nm	
Forward Voltage	V _F	-----	3.5	4.0	V	V _R =5V
Reverse Current	I _R	-----	-----	50	μ A	

Notes:

- 1.Tolerance of Luminous Intensity ±10%**
- 2.Tolerance of Dominant Wavelength ±1nm**
- 3.Tolerance of Forward Voltage ±0.1V**

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Bin Rang Of Dom. Wavelength

Group	Bin	Min	Max	Unit	Condition
A	A9	464.5	467.5	nm	If=20mA
	A10	467.5	470.5		
	A11	470.5	473.5		
	A12	473.5	476.5		

Bin Rang Of Luminous Intensity

Bin	Min	Max	Unit	Condition
N1	28.5	36.0	mcd	If=20mA
N2	36.0	45.0		
P1	45.0	57.0		
P2	57.0	72.0		

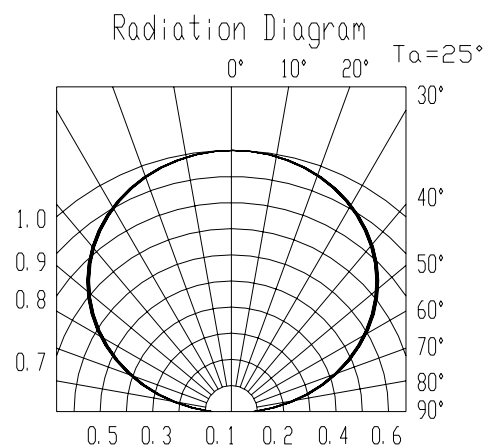
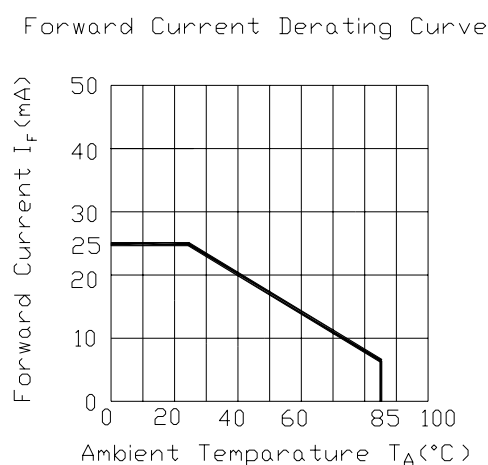
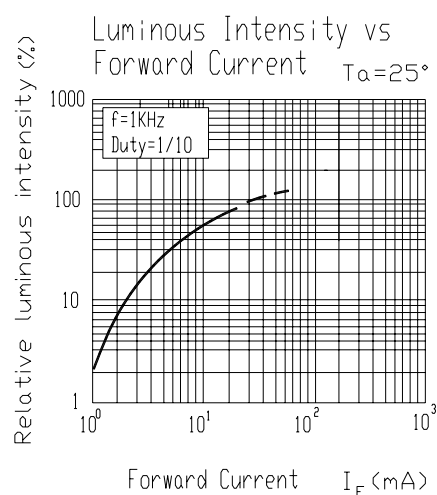
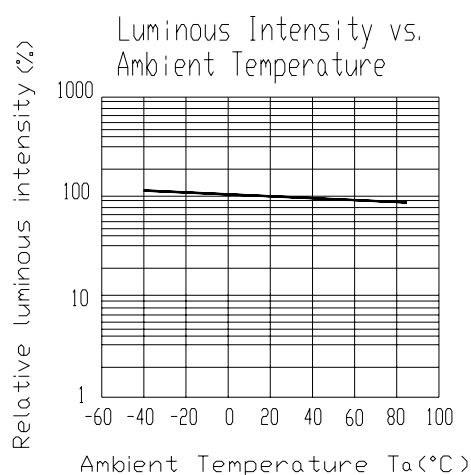
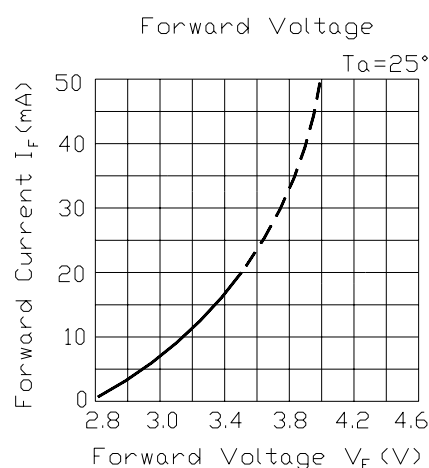
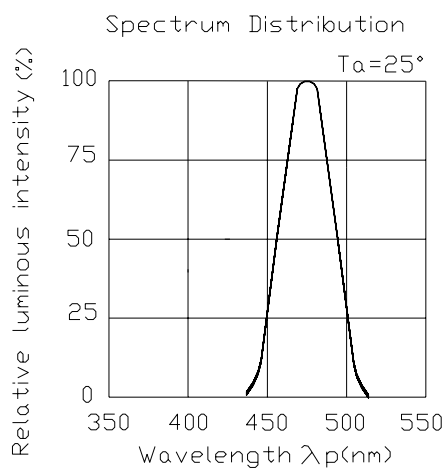
Notes:

1.Tolerance of Luminous Intensity $\pm 10\%$

2.Tolerance of Dominant Wavelength $\pm 1\text{nm}$

15-21/BHC-AN1P2/2T

Typical Electro-Optical Characteristics



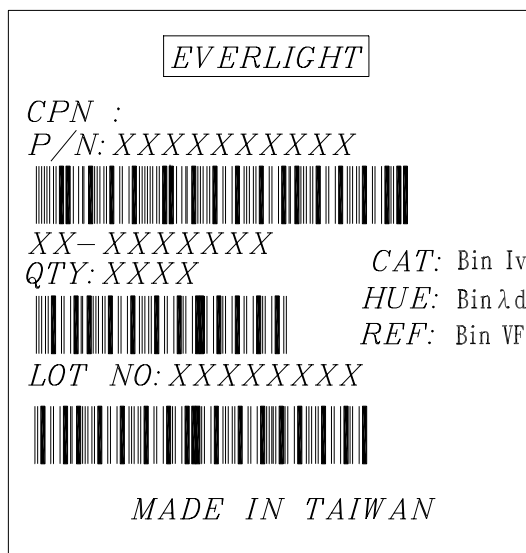
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Label explanation

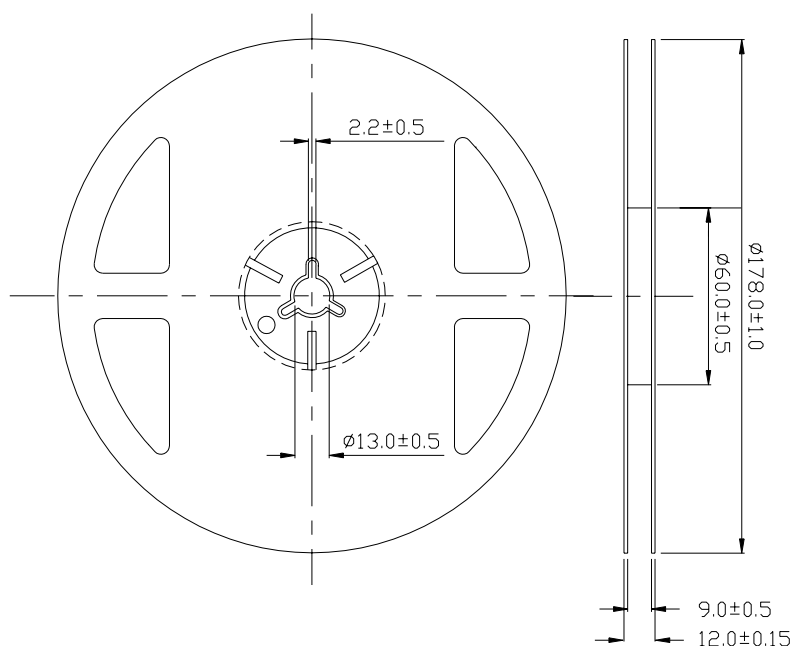
CAT: Luminous Intensity Rank

HUE: Dom. Wavelength Rank

REF: Forward Voltage Rank



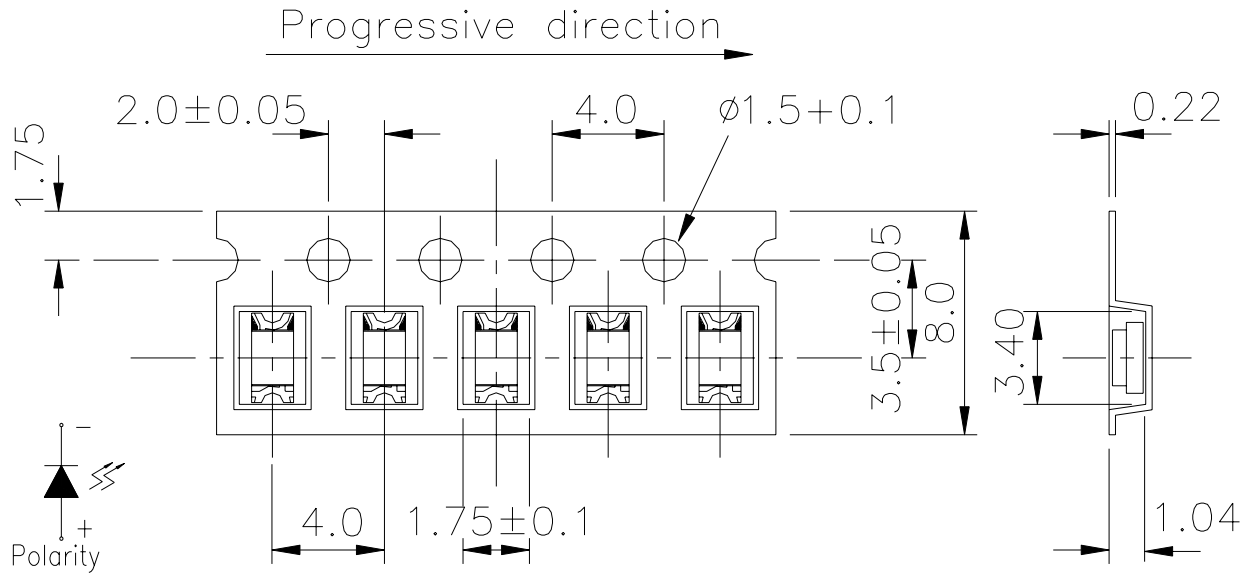
Reel Dimensions



Note: The tolerance unless mentioned is $\pm 0.1\text{mm}$, unit is mm.

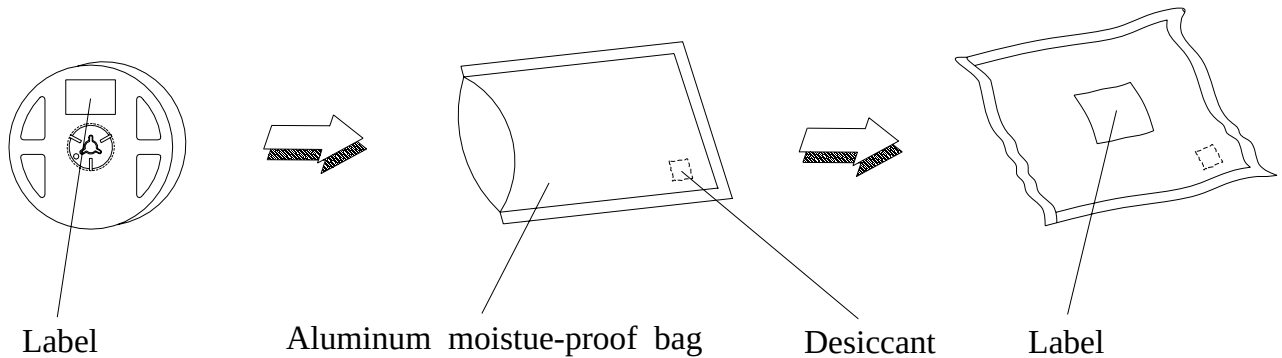
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Carrier Tape Dimensions: Loaded quantity 2000 PCS per reel



Note: The tolerance unless mentioned is $\pm 0.1\text{mm}$, unit is mm.

Moisture Resistant Packaging



15-21/BHC-AN1P2/2T
Reliability Test Items And Conditions

The reliability of products shall be satisfied with items listed below.

Confidence level : 90%

LTPD : 10%

No.	Items	Test Condition	Test Hours/Cycles	Sample Size	Ac/Re
1	Reflow Soldering	Temp. : 260°C±5°C 5 sec.	6 Min.	22 Pcs.	0/1
2	Temperature Cycle	H : +100°C 15min ∫ 5 min L : -40°C 15min	300 Cycles	22 PCS.	0/1
3	Thermal Shock	H : +100°C 5min ∫ 10 sec L : -10°C 5min	300 Cycles	22 PCS.	0/1
4	High Temperature Storage	Temp. : 100°C	1000 Hrs.	22 PCS.	0/1
5	Low Temperature Storage	Temp. : -40°C	1000 Hrs.	22 PCS.	0/1
6	DC Operating Life	I _F = 20 mA	1000 Hrs.	22 PCS.	0/1
7	High Temperature / High Humidity	85°C/85% RH	1000 Hrs.	22 PCS.	0/1

Precautions For Use**1. Over-current-proof**

Customer must apply resistors for protection , otherwise slight voltage shift will cause big current change (Burn out will happen).

2. Storage

2.1 Do not open moisture proof bag before the products are ready to use.

2.2 Before opening the package, the LEDs should be kept at 30°C or less and 90%RH or less.

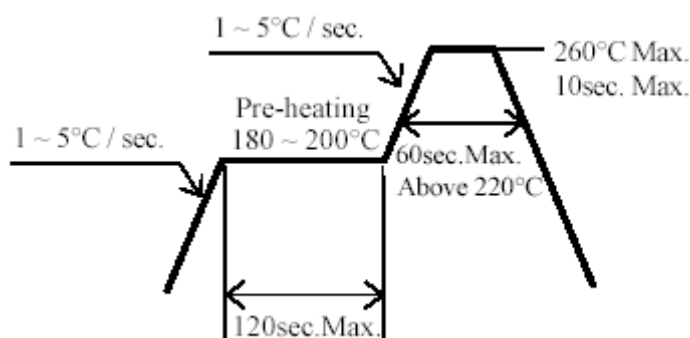
2.3 The LEDs should be used within a year.

2.4 After opening the package, the LEDs should be kept at 30°C or less and 70%RH or less.

2.5 The LEDs should be used within 168 hours (7 days) after opening the package.

2.6 If the moisture absorbent material (silica gel) has faded away or the LEDs have exceeded the storage time, baking treatment should be performed using the following conditions.

Baking treatment : 60±5°C for 24 hours.

3. Soldering Condition**3.1 Lead solder temperature profile**

3.2 Reflow soldering should not be done more than two times.

3.3 When soldering, do not put stress on the LEDs during heating.

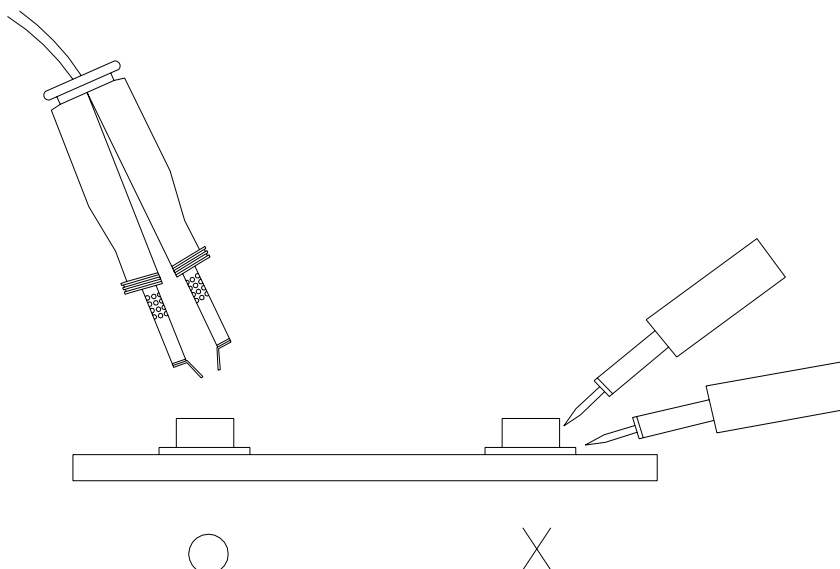
3.4 After soldering, do not warp the circuit board.

4. Soldering Iron

Each terminal is to go to the tip of soldering iron temperature less than 280°C for 3 seconds within once in less than the soldering iron capacity 25W. Leave two seconds and more intervals, and do soldering of each terminal. Be careful because the damage of the product is often started at the time of the hand solder.

15-21/BHC-AN1P2/2T**5.Repairing**

Repair should not be done after the LEDs have been soldered. When repairing is unavoidable, a double-head soldering iron should be used (as below figure). It should be confirmed beforehand whether the characteristics of the LEDs will or will not be damaged by repairing.

**EVERLIGHT ELECTRONICS CO., LTD.**

Office: No 355,Zhong Shan North Rd ,WuJiang,
Economy Development Zone(YunXi Area),
SongLing Town,WuJiang City,JiangSu PRC, China.

Tel: 0512-63409123-1603

Fax: 0512-63409123-1510

<http://www.everlight.com>